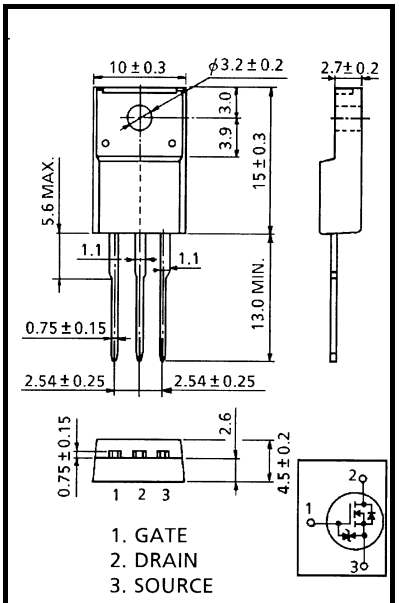
TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π−MOSV)

2SK2965

Switching Regulator, DC−DC Converter and Motor Drive Applications

- Low drain−source ON resistance : $R_{DS\ (ON)}$ = 0.15 Ω (typ.)
- High forward transfer admittance : $|Y_{fs}|$ = 10 S (typ.)
- Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 200 V)
- Enhancement mode : V_{th} = 1.5~3.5 V (V_{DS} = 10 V, I_D = 1 mA)

Unit: mm



JEDEC	—
JEITA	SC-67
TOSHIBA	2-10R1B

Weight: 1.9 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain–source voltage		V_{DSS}	200	V
Drain–gate voltage (R_{GS} = 20 kΩ)		V_{DGR}	200	V
Gate–source voltage		V_{GSS}	±20	V
Drain current	DC (Note 1)	I_D	11	A
	Pulse (Note 1)	I_{DP}	33	A
Drain power dissipation (Tc = 25°C)		P_D	35	W
Single pulse avalanche energy (Note 2)		E_{AS}	115	mJ
Avalanche current		I_{AR}	11	A
Repetitive avalanche energy (Note 3)		E_{AR}	3.5	mJ
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	−55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th\ (ch–c)}$	3.57	°C / W
Thermal resistance, channel to ambient	$R_{th\ (ch–a)}$	62.5	°C / W

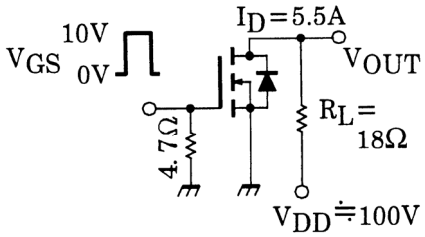
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 50 V, T_{ch} = 25°C (initial), L = 1.53 mH, R_G = 25 Ω, I_{AR} = 11 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device.
Please handle with caution.

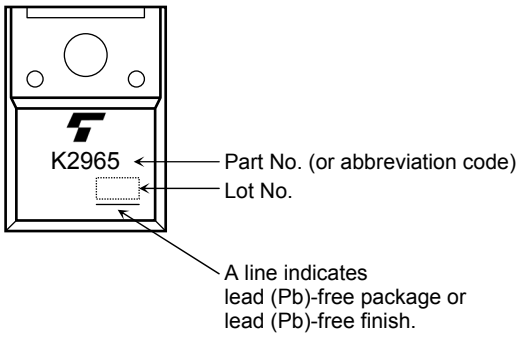
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	—	—	±10	μA
Drain cut–off current		I_{DSS}	V_{DS} = 200 V, V_{GS} = 0 V	—	—	100	μA
Drain–source breakdown voltage		$V_{(BR)\ DSS}$	I_D = 10 mA, V_{GS} = 0 V	200	—	—	V
Gate threshold voltage		V_{th}	V_{DS} = 10 V, I_D = 1 mA	1.5	—	3.5	V
Drain–source ON resistance		$R_{DS\ (ON)}$	V_{GS} = 10 V, I_D = 5.5 A	—	0.15	0.26	Ω
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = 10 V, I_D = 5.5 A	5.0	10	—	S
Input capacitance		C_{iss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	—	1200	—	pF
Reverse transfer capacitance		C_{rss}		—	100	—	
Output capacitance		C_{oss}		—	290	—	
Switching time	Rise time	t_r		—	15	—	ns
	Turn–on time	t_{on}		—	25	—	
	Fall time	t_f		—	10	—	
	Turn–off time	t_{off}		—	75	—	
Total gate charge (gate–source plus gate–drain)		Q_g	V_{DD} ≈ 100 V, V_{GS} = 10 V, I_D = 10 A	—	30	—	nC
Gate–source charge		Q_{gs}		—	20	—	
Gate–drain (“miller”) Charge		Q_{gd}		—	10	—	

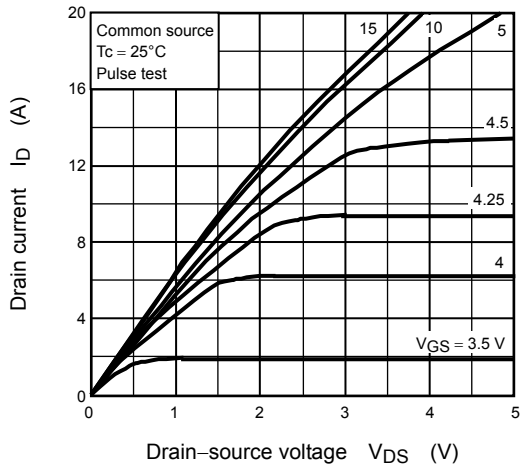
Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	11	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	33	A
Forward voltage (diode)	V_{DSF}	I_{DR} = 11 A, V_{GS} = 0 V	—	—	−2.0	V
Reverse recovery time	t_{rr}	I_{DR} = 11 A, V_{GS} = 0 V, I_{DR} / dt = 100 A / μs	—	175	—	ns
Reverse recovery charge	Q_{rr}		—	1.3	—	μC

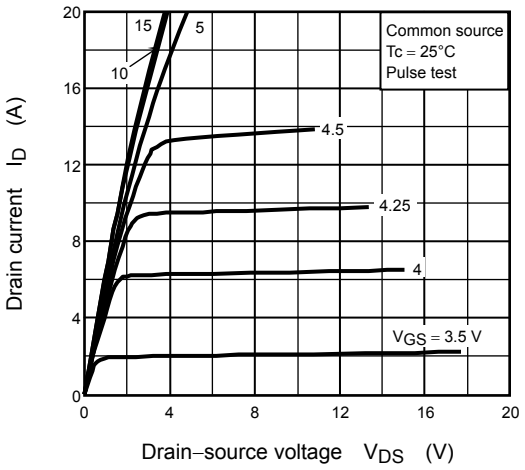
Marking



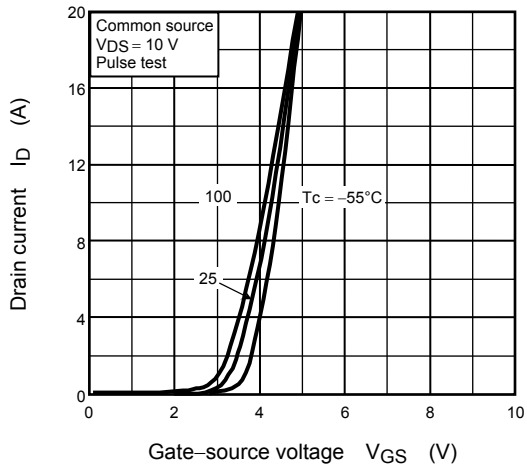
$I_D - V_{DS}$



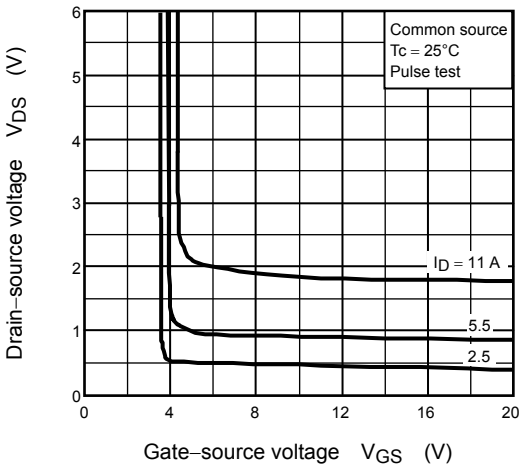
$I_D - V_{DS}$



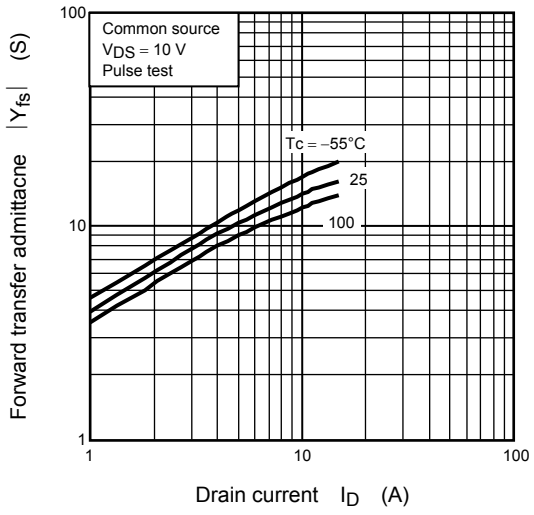
$I_D - V_{GS}$



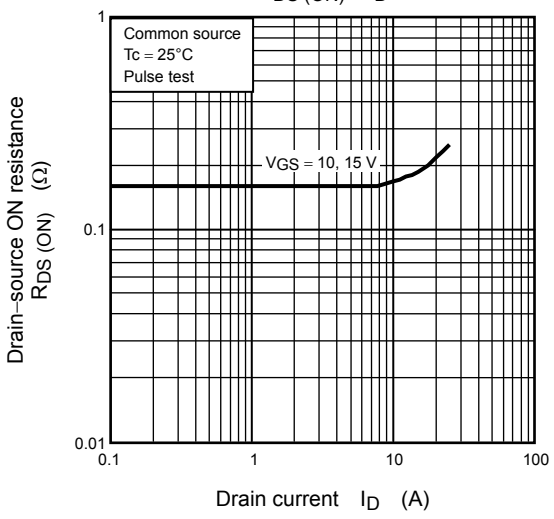
$V_{DS} - V_{GS}$



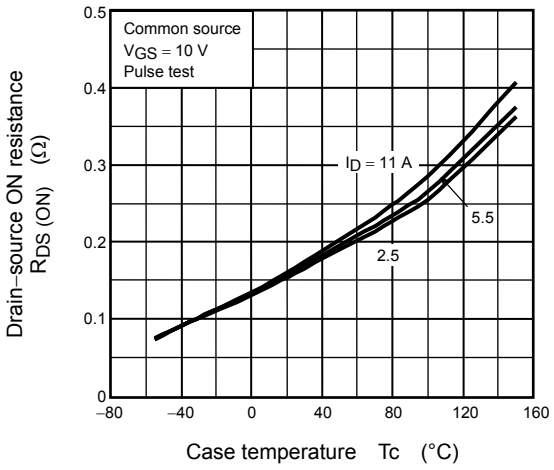
$|Y_{fs}| - I_D$



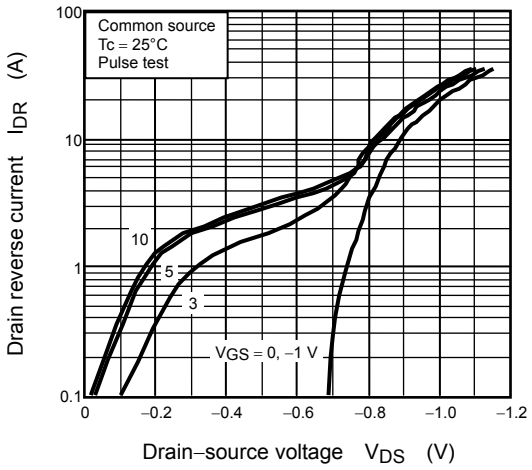
$R_{DS\ (ON)} - I_D$



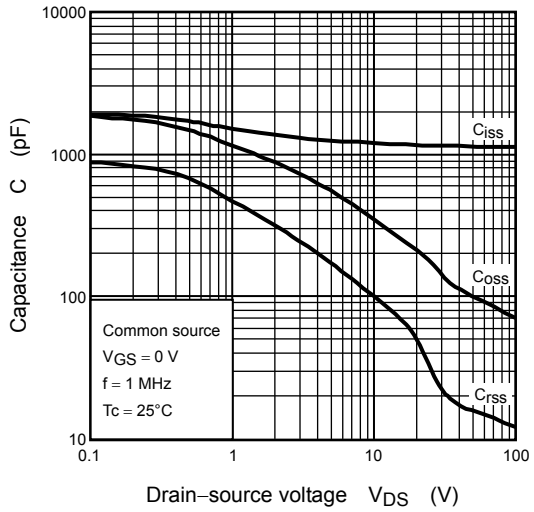
$R_{DS\ (ON)}$ – Tc



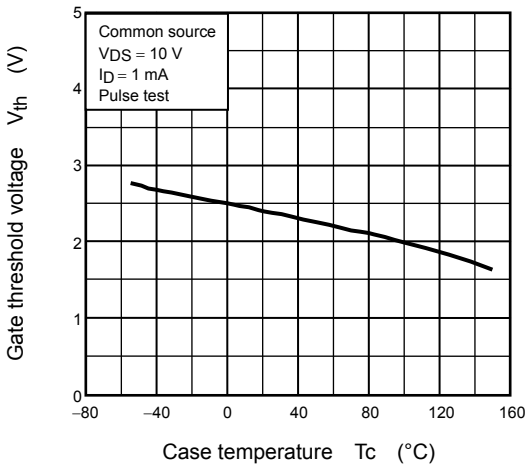
I_{DR} – V_{DS}



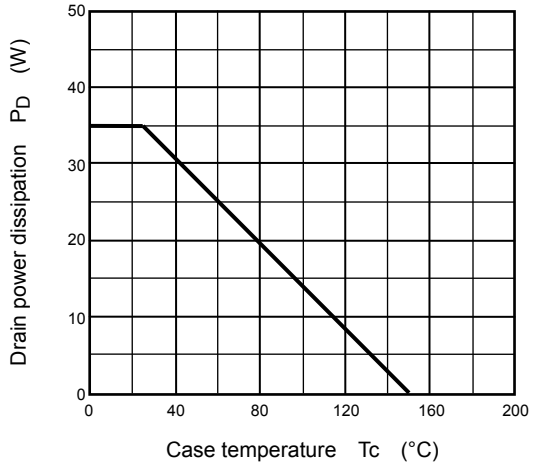
Capacitance – V_{DS}



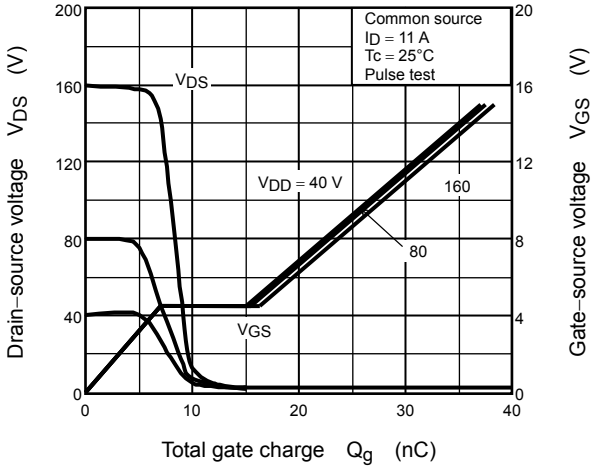
V_{th} – Tc

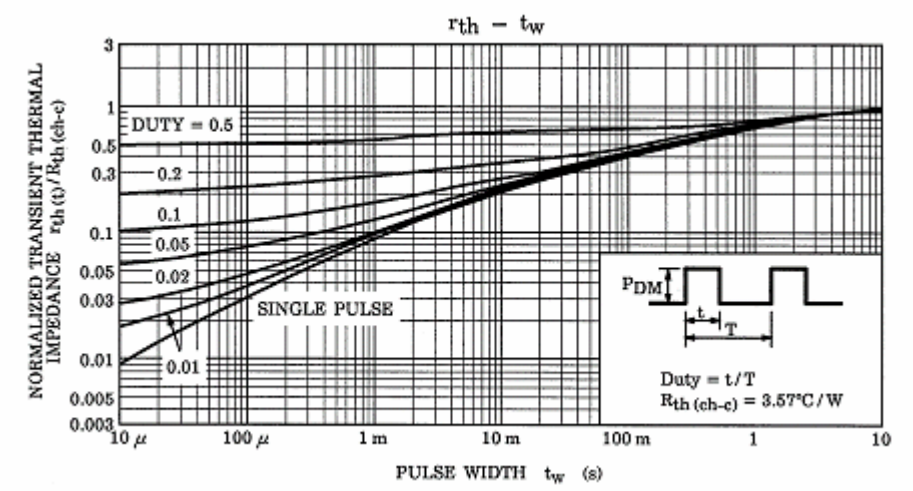


P_D – Tc

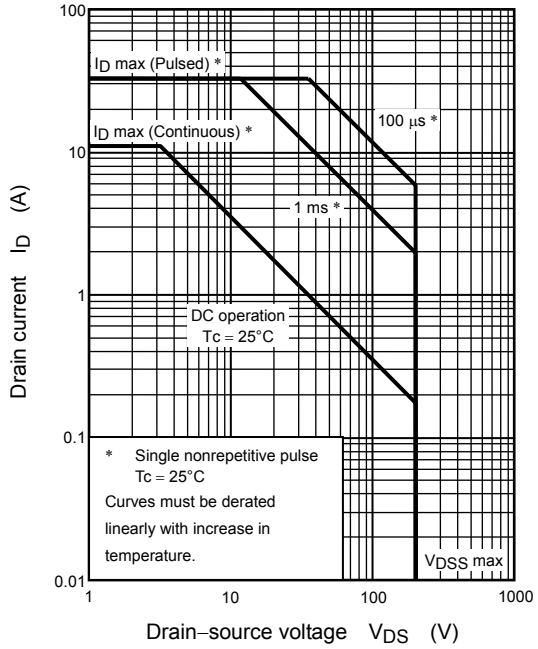


Dynamic input/output characteristics

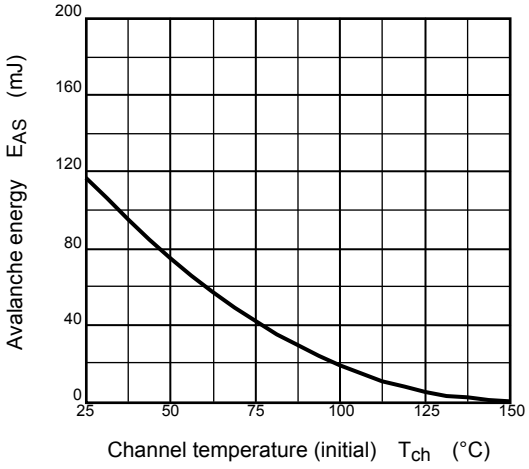


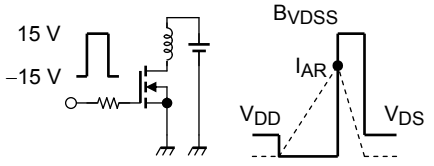


Safe operating area



E_{AS} – T_{ch}





Test circuit Wave form

R_G = 25 Ω
V_{DD} = 50 V, L = 1.53 mH

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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20070701-EN

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